

FFA120UP60DN Ultrafast Recovery Power Rectifier

WWW.DZSC

Features

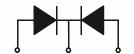
- · High voltage and high reliability
- · High speed switching
- Low forward voltage

Applications

- General purpose
- · Switching mode power supply
- · Free-wheeling diode for motor application
- · Power switching circuits



TO-3P



1. Anode 2. Cathode 3. Anode

Absolute Maximum Ratings (per diode) T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Peak Repetitive Reverse Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 50°C	120	A
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	360	А
T _{J,} T _{STG}	Operating Junction and Storage Temperature	- 65 to +150	°C

Thermal Characteristics T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	0.88	°C/W



Electrical Characteristics (per diode) T_a = 25°C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} *	Maximum Instantaneous Forward Voltage I _F = 60A I _F = 60A	T _C = 25 °C T _C = 100 °C	-		2.2 2.0	V
I _{RM} *	Maximum Instantaneous Reverse Current @ rated V _R	T _C = 25 °C T _C = 100 °C	-	-	25 250	μΑ
t _{rr} I _{rr} Q _{rr}	Maximum Reverse Recovery Time Maximum Reverse Recovery Current Maximum Reverse Recovery Charge (I _F =60A, di/dt = 200A/μs)		- - -	- - -	90 9 405	ns A nC
W _{AVL}	Avalanche Energy (L = 40mH)		20	-	-	mJ

^{*} Pulse Test: Pulse Width=300 μ s, Duty Cycle=2%

Typical Performance Characteristics

Figure 1. Typical Forward Voltage Drop vs. Forward Current

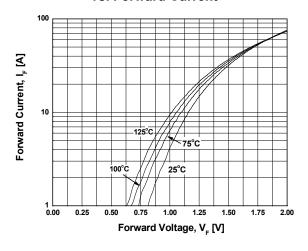


Figure 3. Typical Junction Capacitance

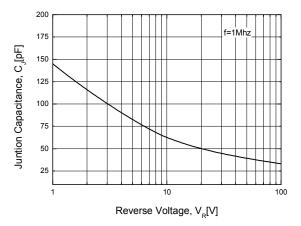


Figure 5. Typical Reverse Recovery Current vs. di/dt

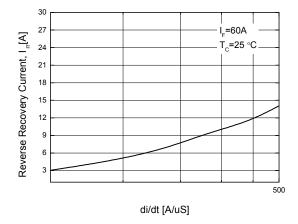


Figure 2. Typical Reverse Current vs. Reverse Voltage

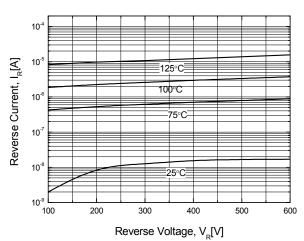


Figure 4. Typical Reverse Recovery Time vs. di/dt

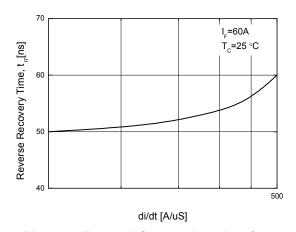
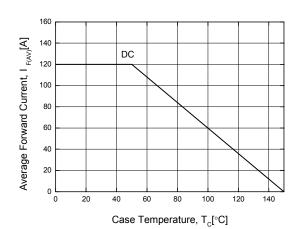
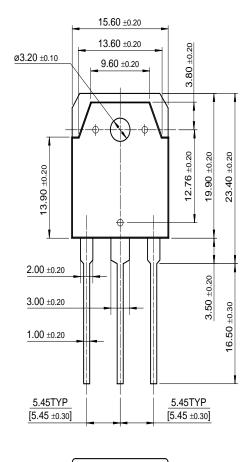


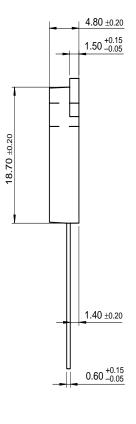
Figure 6. Forward Current Derating Curve



Mechanical Dimensions

TO-3P







Dimensions in Millimeters

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Rev. I15